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Attorney Docket No. 108298705US
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U.S. PATENT & TRADEMARK OFFICE
INFORMATION DISCLOSURE
STATEMENT BY APPLICANT
Form PTO-1449 (Modified)
(Use several sheets if necessary)

				COMPLETE IF KNOWN	
				Application Number	10/665,219
				Confirmation Number	6284
				Filing Date	September 17, 2003
				First Named Inventor	Whonchee Lee
				Group Art Unit	3723
				Examiner Name	Dung V. Nguyen
Sheet	1	of	1	Attorney Docket No.	108298705US

U.S. PATENT DOCUMENTS					
Examiner Initials*	Cite No.	U.S. Patent or Application		Name of Patentee or Inventor of Cited Document	Date of Publication or Filing Date of Cited Document
		NUMBER	Kind Code (if known)		
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EXAMINER <i>Dung V. Nguyen</i>	DATE CONSIDERED 12-1-2004
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